



# STEVAL-SPBT3ATV3

## USB dongle for the Bluetooth® class 2 SPBT2632C2A.AT2 module

Data brief

### Features

- Based on a V3.0 Bluetooth® class 2 module SPBT2632C2A.AT2
- USB interface and power supply
- Supports reprogrammability via USB interface
- Reset button
- Antenna onboard
- RoHS compliant

### Description

The STEVAL-SPBT3ATV3 demonstration board is a design tool to evaluate the SPBT2632C2A.AT2 module in a quick and simple way.

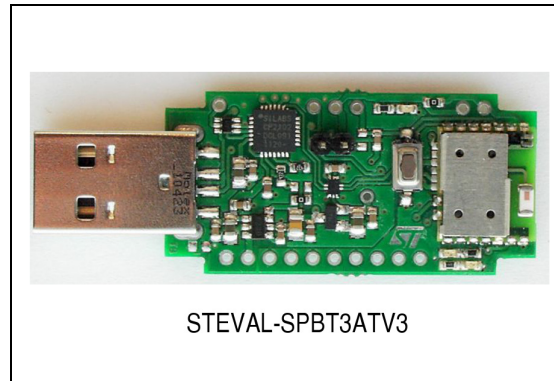
The dongle includes the RF antenna and the USB connector.

The USB connector is used to connect the dongle to a PC, to access the Bluetooth® module, and to supply the dongle.

The STEVAL-SPBT3ATV3 includes downloaded FW, enabling the user to create a Bluetooth® link with simple AT commands. The AT command list is detailed in the User Manual UM1547.

The AN4127 application note describes how to get started with the STEVAL-SPBT3ATV3.

The SPBT2632C2A.AT2-based dongle is a demonstration tool only, to be used strictly for evaluation purposes. It is not a product in itself.



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# 1 Recommended operating conditions

**Table 1. Recommended operating conditions**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
VDD	Board supply voltage	-40 °C < T < 85 °C	4.5	5	5.5	V
Top	Operating case temperature range		-40		+85	°C

## 2 Dongle layout

Figure 1. Dongle component layout, front side

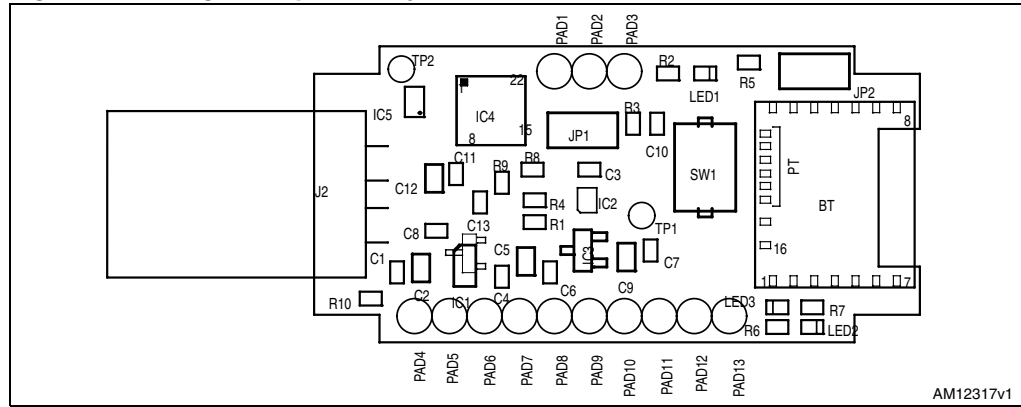
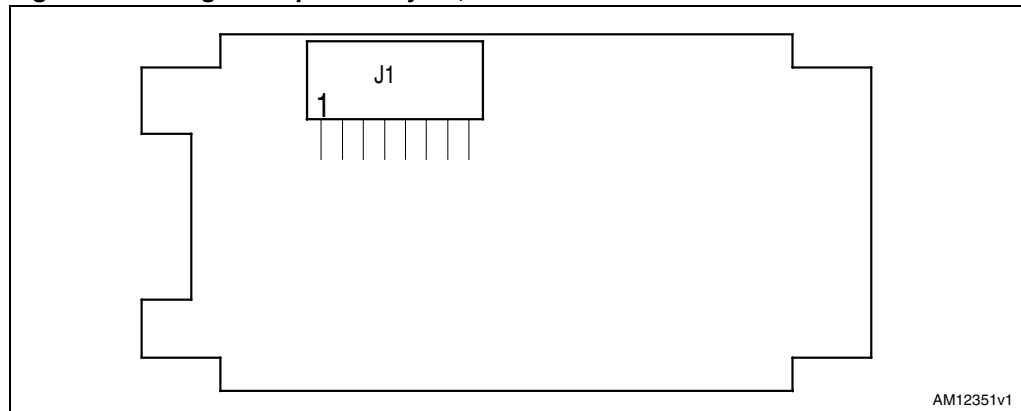


Figure 2. Dongle component layout, bottom side

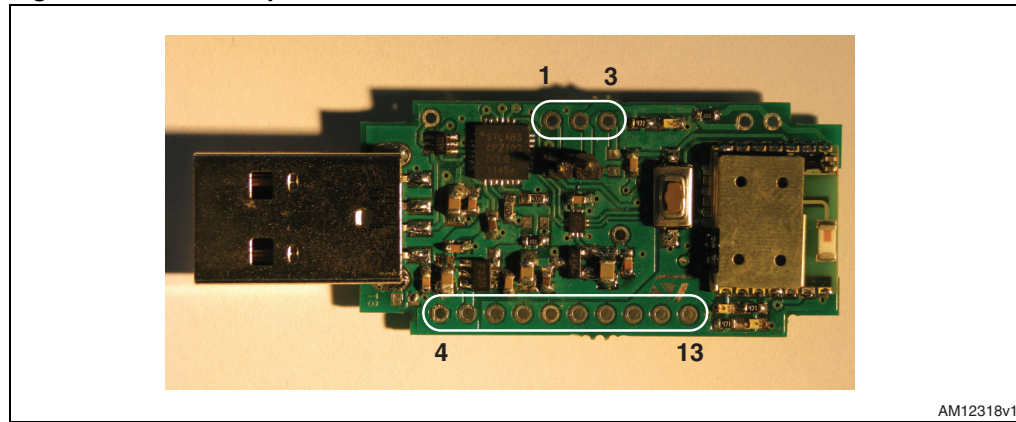


### 3 I/O connections

#### 3.1 PAD description

Other than the USB plug, some pads are also available. In fact, pads PAD1 to PAD13 make the SPBT2632C2A.AT2 pins available to the user.

**Figure 3. Available pads**



AM12318v1

Table 2 gives a description of these pads.

**Table 2. Pad connections**

Description		
(PAD)	1	BOOT0 - Boot pin used for firmware downloading - used for testing purposes
	2	3.3 V (module – LED1 is connected to this PAD)
	3	RESETN - reset - connected in parallel to onboard reset switch
	4	GND
	5	+5 V (USB)
	6	LPO (external 32.768 kHz frequency input to allow deep sleep and sniff mode Bluetooth module functional states)
	7	GPIO07 – general purpose I/O
	8	GPIO01 – general purpose I/O (see note) (LED2 is connected to this GPIO)
	9	GPIO02 – general purpose I/O (see note)
	10	GPIO03 – general purpose I/O (see note)
	11	GPIO04 – general purpose I/O (see note) (LED3 is connected to this GPIO)
	12	GPIO06 – general purpose I/O see note)
	13	GPIO05 – general purpose I/O

*Note: Default configuration - different configurations can be chosen (see datasheet).*



## 5 Revision history

Table 3. Document revision history

Date	Revision	Changes
12-Jun-2012	1	Initial release.
25-Jun-2012	2	Modified: photo in the cover page, description, <a href="#">Figure 1</a> and <a href="#">4</a>

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